

An Implementation That Facilitate Anticipatory Test Forecast For IM-Chips

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Abstract: These designs pose significant challenges towards the funnel management plan, flow, and tools. This paper introduces several test logic architectures that facilitate preemptive test scheduling for SC circuits with embedded deterministic test-based test data compression. This paper presents several techniques used to resolve problems surfacing when using scan bandwidth management to large industrial multicore system-on-chip (SC) designs with embedded test data compression. Exactly the same solutions allow efficient handling of physical constraints in realistic programs. Finally, condition-of-the-art SC test scheduling calculations are architected accordingly by looking into making provisions for: 1) establishing time-effective test designs 2) optimization of SC pin partitions 3) allocation of core-level channels according to scan data volume and 4) more flexible core-wise use of automatic test equipment funnel sources. An in depth situation study is highlighted herein with a number of experiments permitting someone to learn to compromise different architectures and test-related factors.

Keywords: Embedded Deterministic Test (EDT); Scan-Based Test; Test Access Mechanism (TAM); Test Application Time; Test Compression; Test Scheduling;

I. INTRODUCTION

Applying a hierarchical DFT methodology for designs with a lot of cores poses significant challenges. This trend has boosted the growing recognition of system-on-chip (SC) designs due to remarkable ability to encapsulate many disparate kinds of complex IP cores running at different clock rates with various power needs and multiple power-supply current levels. Many SC-based test schemes suggested to date utilize devoted instrumentation, including test access systems (TAMs) and test wrappers TAMs are usually accustomed to transfer test data between your SC pins and embedded cores, whereas test wrappers make up the interface between your core and SC atmosphere. Solutions concerning both TAMs and wrappers accomplish such tasks as optimizing test interface architecture or control logic while addressing routing and layout constraints or hierarchy of cores, scheduling test methods, and minimizing power consumption. The integrated plan cuts down on the test time by optimizing devoted TAMs and pin-count aware test scheduling. Packet-switched systems-on-chip can replace devoted TAMs in testing of SC by delivering test data with an on-chip communication infrastructure. To begin with, the amount of on-chip pins is restricted and doesn't suffice they are driving all cores in parallel. Because of the pin restrictions, it's impossible to look for the optimal allocation of pins to cores to find the best

compression [1]. In addition, since a specific core could be reused in multiple designs, an ideal quantity of funnel pins with this core when baked into one design may invalidate test reuse in other kinds. Under such conditions, the on-chip integrators collect data for those individual cores, check out the data together with all constraints for that design, after which by hand determine test schedules. This may lead to suboptimal test data volume and compromised test application time, especially due to some outlier blocks getting large pattern counts (Computers). Bandwidth management mitigates the dependence of core channels on the amount of available on-chip pins, enables automatic scheduling of tests by looking into making it transparent towards the customers, and considerably improves test planning in the core level. Additionally, it arbitrates the discussing from the on-chip funnel pins, therefore guaranteeing the very best data volume and test time reductions in price for the general design. Within this paper, we present a bandwidth management plan for hierarchical designs that allows an artist compromise fixed and versatile funnel allocations per core in addition to physical constraints to reduce the routing overhead from the TAM-based systems. In addition, several strategies to provide the control data during test are examined altogether with a brand new scheduling formula that enables altering the In and output funnel allocations when switching the funnel designs.

II. RELATED WORK

The SC test atmosphere of the paper comprises two switching systems, as introduced. An exterior ATE In funnel i (ICi) feeds an In-switching network that reroutes compressed test data to various cores. SC test atmosphere with on-nick compression, in line with the control data created with a test scheduler. Because the scan routing pathways in the nick-level test pins towards the core-level test pins are dynamically selected by designs, this interconnection network can also be known to like a dynamic scan router (DSR). Identical modules may share exactly the same test data within the broadcast mode. Additionally to individual EDT decompresses, each core features X-masking logic safeguarding its response compactor against unknown states and hooking up the main by having an output-switching network. This network enables the compressed output streams from successive cores to achieve an output funnel i (OCi), and also to be delivered back towards the ATE. To be able to facilitate test pattern reuse, test wrappers isolate all cores so they are separate from one another. The In DSR includes DE multiplexers whose number matches the amount of ATE In channels. Given several test designs, each DE multiplexer connects the related funnel to one of many destination cores, as shown by the information of address register [2]. The amount of ATE in channels can't be smaller sized compared to capacity from the biggest single core when it comes to its EDT In. Clearly, within the worst situation, we are able to still test the biggest cores, individually. Typically, low-order By each core are utilized more others. Hence, OR gates are deployed to make sure these In will get data from greater than a single ATE funnel to improve versatility of the test scheduler. Because of the ATE In channels, the connected DE multiplexers, and all sorts of cores with OR gates driving their EDT In, the particular connections between these terminals are arranged the following. The EDT In (alternatively, OR gate In, or no) are associated with the DE multiplexers in a way that n EDT By confirmed core are associated with n different ATE In channels, and every ATE funnel serves roughly exactly the same quantity of cores. This process yields the particular size the In DE multiplexers as well as their control registers. Some final adjustments inside a single module will also be easy to simplify the resultant DSR layout and steer clear of pricey and lengthy connections, channels. It consists of numerous multiplexers so that each multiplexer serves for connecting several cores having a designated ATE output funnel [3]. Again, the address registers specify which cores should be observed for any given number of test designs. The output funnel mapping is transported in a way much like those of the In DSR. The entire process of developing the bottom class terminates when either there aren't any more setup classes

complementary using the base, or among the constraints can't be satisfied. The merging formula removes then your first element from list.

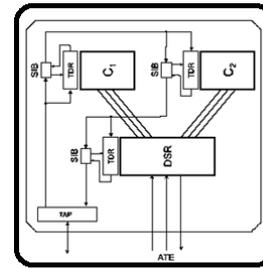


Fig.1. Transfer control data using IJTAG network

III. PROPOSED SYSTEM CONTROL

The approach summarized, doesn't make any sort of provisions for way control information is shipped to SC test logic to be able to setup test designs. It seems, however, that the amount of test designs, and therefore the quantity of control data one should employ and transfer between your ATE and DSR address registers, may noticeably impact test scheduling and also the resultant test time. Consequently, we start this paper by examining three alternative schemes you can use to upload control bits and show the way they determine the ultimate SC test logic architecture. The IEEE 1687 is really a suggested standard for being able to access on-nick make sure debug features through the IEEE 1149.1 test access port (TAP). The objective of this internal Joint Test Action Group (IJTAG) standard would be to automate the way in which it's possible to manage on-nick instruments, and also to describe a language for interacting together through the IEEE 1149.1 test data registers (TDRs). If there's an IJTAG network on the SC, and also the final amount of test designs is comparatively small, it's possible to utilize it to provide the control data, TAP could be expected to enable an evaluation path through the IEEE 1687 segment insertion bits (SIBs). Every SIB can be used either to enable or disable the inclusion of the instrument in to the path from the test data In a test data output. The TDR in DSR has got the control data showing which core and which of their test channels are linked to which ATE channels [4]. The benefit of while using IJTAG network to provide the DSR control data is a straightforward and good way to implement flow because the network is often accustomed to set the cores TDRs. However, this kind of approach is only able to support a restricted quantity of designs. The architecture supports as numerous test designs as needed. However, the control information is always submitted with the ATE channels as a fundamental element of an evaluation vector. The tester bandwidth management in present large SC designs and future kilo-core architectures with considerable

diversity within the design styles and test needs of person modules requires solutions past the abilities of state-of-the-art DFT schemes. findings clearly indicate the DSRs ought to provide each core with funnel sources sufficient to the bandwidth needs [5]. Based on our findings, probably the most appropriate partitions of ATE channels could be acquired by evaluating the related SDVs on sides. It's worth recalling that DSR systems are generic and regular structures that remain separate from enhanced SC pin partitions and SDV needs of person cores. Analysis clearly signifies that modifying DSR systems in compliance using the SDV statistics can keep up with the central role of test scheduling in lessening test application time. Clearly, the price of ATPG recomposing could be high, specifically for designs with 100s of cores. In addition, it might be impossible to improve EDT interface for every core.

IV. CONCLUSION

As proven within this paper, the I/O sources supplied by a tester could be dynamically allotted to selected cores, whereas the entire quantity of channels being used may remain unchanged. As Moore's law is constantly on the provide smaller sized products, designs with a variety of core counts, capacity per core, and per core create a dramatic effect on SC design and test methods. This paradigm clearly requires efficient schemes minimizing the general test application time, while considering physical constraints, particularly, SC pin allocations. Presuming that SC cores are wrapped testable models, this paper studies several practical issues regarding SC-based testing that deploys on-nick test data compression having the ability to dynamically use ATE channels. Experimental results acquired for any large industrial SC design confirm practicality from the suggested schemes as well as their capability to trade-off the amount of test pins, design complexity from the TAM, and test application time. The suggested solutions include techniques accustomed to deliver control data and test scheduling calculations minimizing the general test application time.

V. REFERENCES

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